SURFACE MOUNT

RF Transformer

TC2-1TG2-11+

50Ω 3 to 300 MHz

FEATURES

- Suitable for tin/lead and RoHS solder systems
- Excellent amplitude unbalance, 0.5 dB typ. and phase unbalance, 4 deg. typ. in 1 dB bandwidth
- Aqueous washable

Generic photo used for illustration purposes only

CASE STYLE: AT224-3

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Impedance matching
- Balanced antennas
- Push-pull amplifiers

Qorvo Part No	Description
QPB2318	5-210 MHz 15.5 dB DOCSIS 3.1 Reverse Amplifier
QPB2328	5-210 MHz 17.8 dB DOCSIS 3.1 Reverse Amplifier

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			2		
Frequency Range		5		300	MHz
Insertion Loss*	3-300		1.0		dB
Phase Unbalance	3-300		4		Deg.
Amplitude Unbalance	3-300		0.5		dB

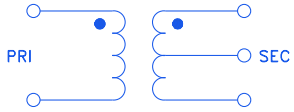
*Insertion Loss is referenced to mid-band loss, 0.4 dB typ.

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.30W
DC Current	30 mA
Idc Center Tap	300 mA Max.

Permanent damage may occur if any of these limits are exceeded.

CONFIG. A



REV. B
ECO-022233
TC2-1TG2-11+
MCL NY
240513

SURFACE MOUNT

RF Transformer

TC2-1TG2-11+

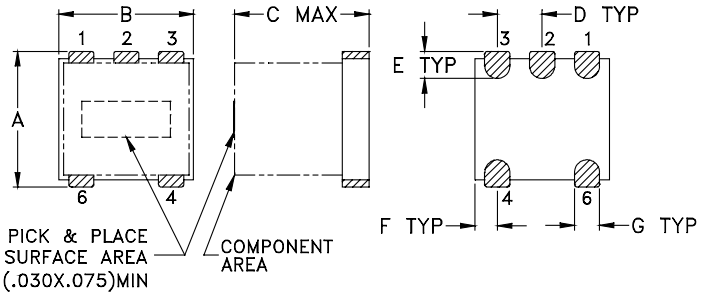
50Ω 3 to 300 MHz

PIN CONNECTIONS

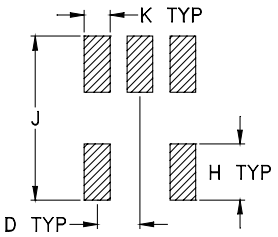
Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
SECONDARY CT	2

PRODUCT MARKING: N/A

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (inch / mm)

A	B	C	D	E	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64

G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.10

TAPE & REEL INFORMATION: F17

SURFACE MOUNT

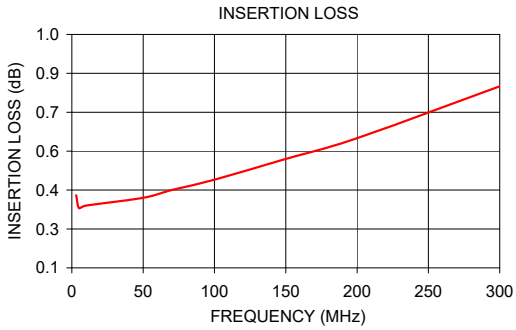
RF Transformer

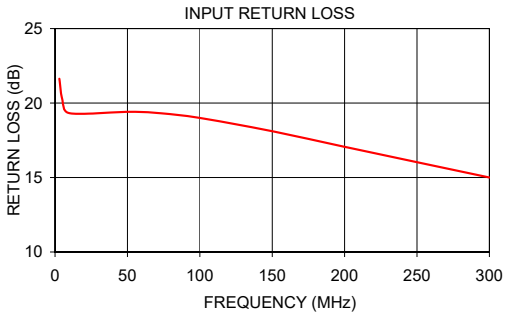
TC2-1TG2-11+

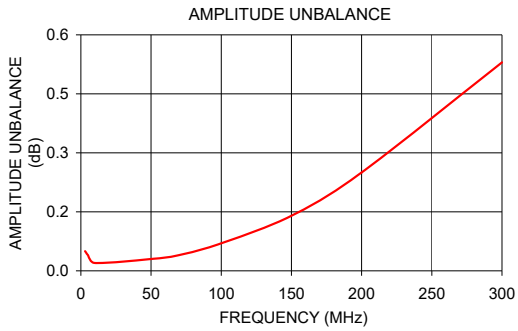
50Ω 3 to 300 MHz

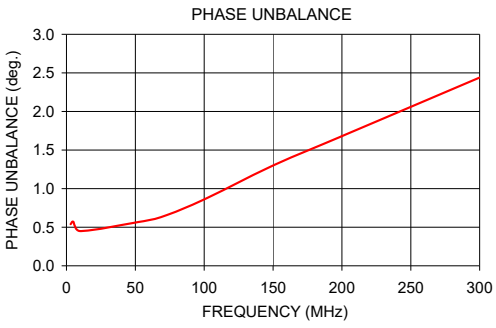
TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
3.00	0.38	21.63	0.05	0.54
5.00	0.33	20.24	0.04	0.57
10.00	0.34	19.32	0.02	0.45
50.00	0.37	19.41	0.03	0.56
70.00	0.40	19.34	0.04	0.64
100.00	0.44	19.00	0.07	0.86
150.00	0.52	18.11	0.14	1.30
200.00	0.60	17.06	0.25	1.68
300.00	0.80	15.00	0.53	2.44









NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

RF Transformer TC2-1TG2-11+

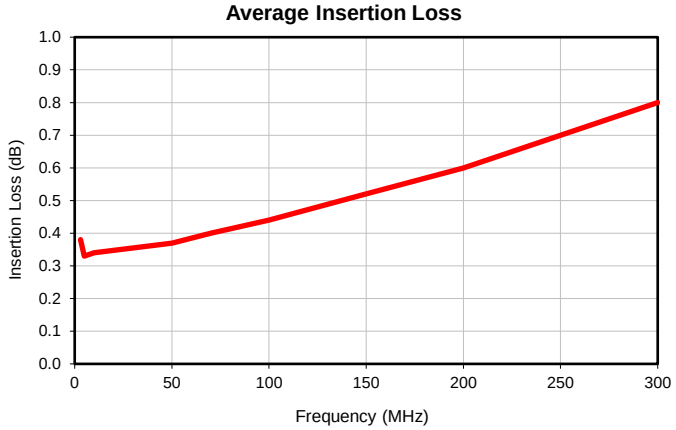
Typical Performance Data

FREQUENCY MHz	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
3	0.38	21.63	0.05	0.54
5	0.33	20.24	0.04	0.57
10	0.34	19.32	0.02	0.45
50	0.37	19.41	0.03	0.56
70	0.40	19.34	0.04	0.64
100	0.44	19.00	0.07	0.86
150	0.52	18.11	0.14	1.30
200	0.60	17.06	0.25	1.68
300	0.80	15.00	0.53	2.44

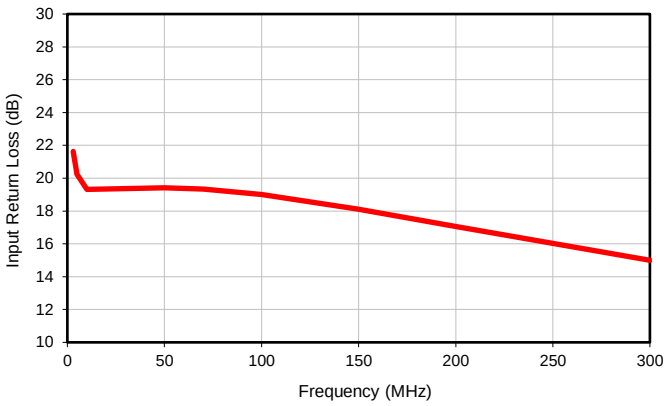
RF Transformer TC2-1TG2-11+

Typical Performance Data

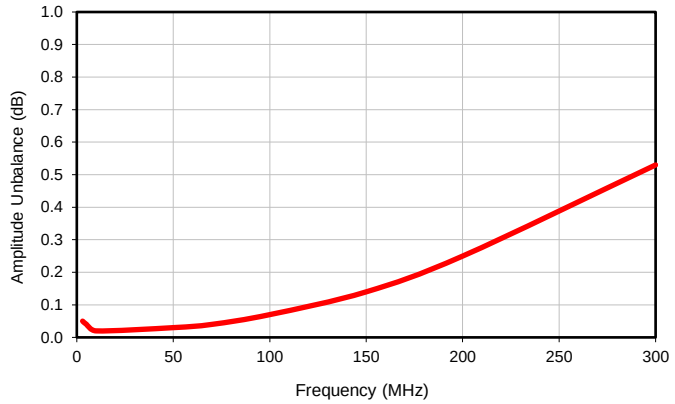
Average Insertion Loss



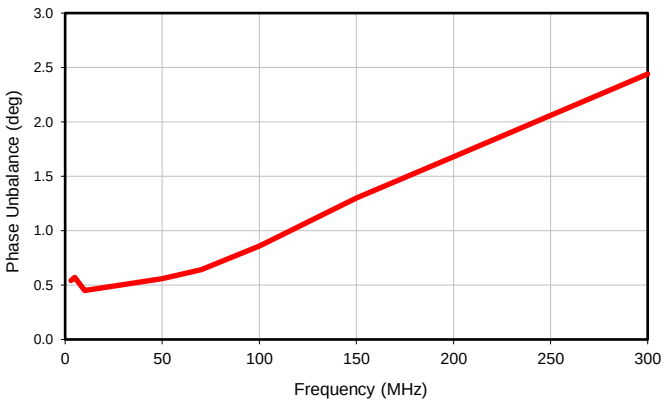
Input Return Loss



Amplitude Unbalance



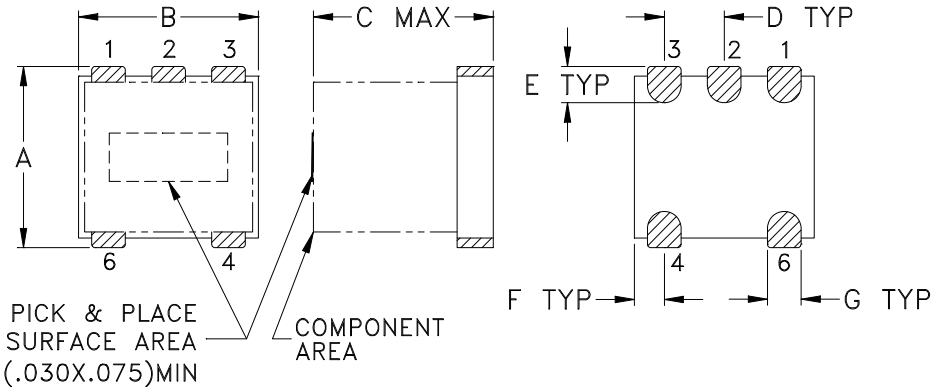
Phase Unbalance



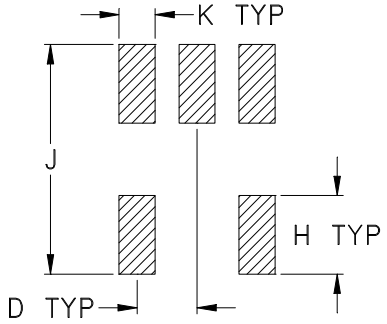
Case Style AT

Outline Dimensions

AT224-3



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224-3	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: 3.15-5.12 µ inch (.08-.130 microns) Gold over 78–236 µ inch (1.98-6.0 microns) Nickel plate.

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RF/IF MICROWAVE COMPONENTS

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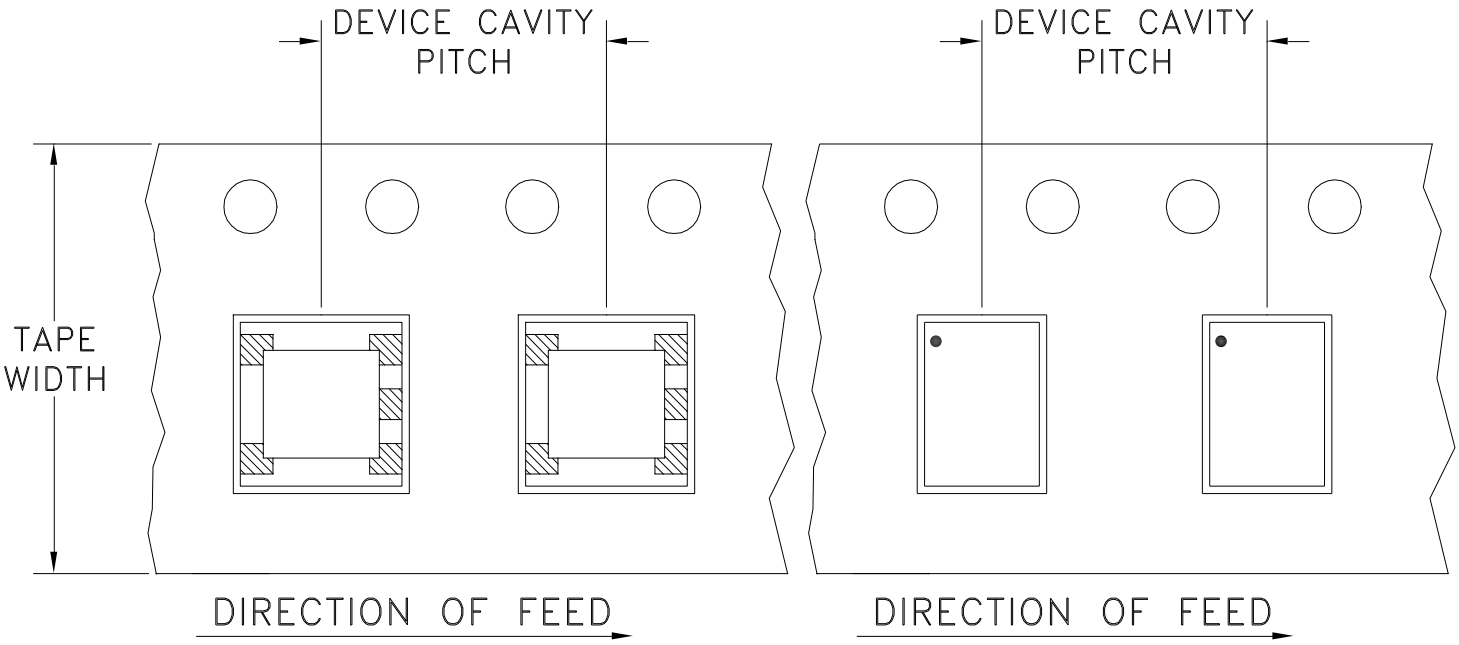
Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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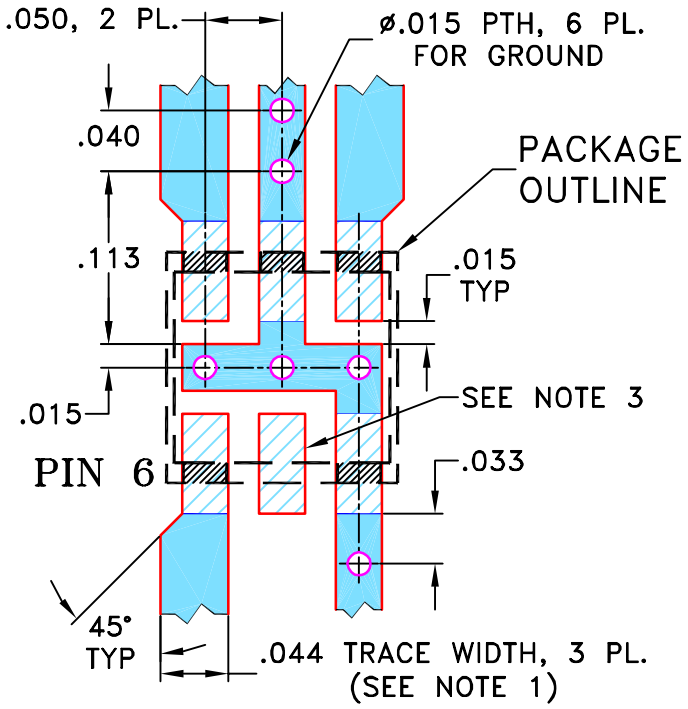
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M106563	NEW RELEASE	08/23/06	AV	IG

SUGGESTED MOUNTING CONFIGURATION FOR AT224/DB714 CASE STYLE, "gs/ha/hd" PIN CONNECTIONS (FOR SINGLE ENDED TO BALANCED APPLICATION)



NOTES:
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	07/28/06
TOLERANCES ON:	CHECKED	IL	08/23/06
2 PL DECIMALS ±	APPROVED	IG	08/23/06
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

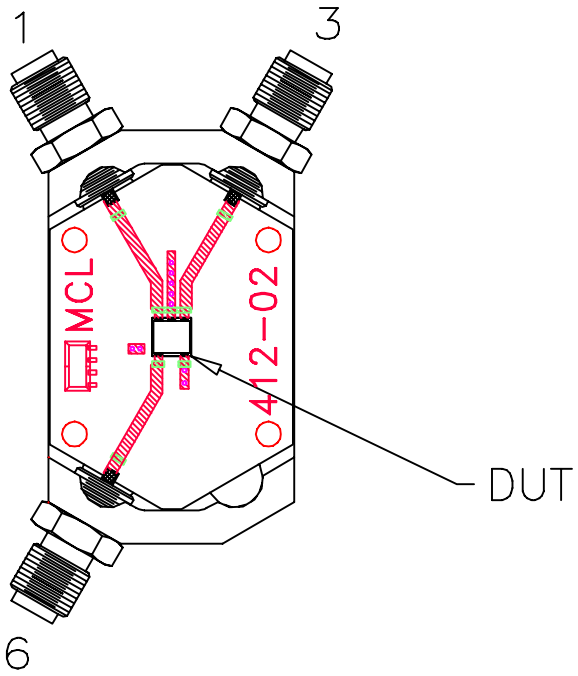
PL, gs/ha/hd, AT224/DB714, TC/TCM, TB-145

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-244	OR

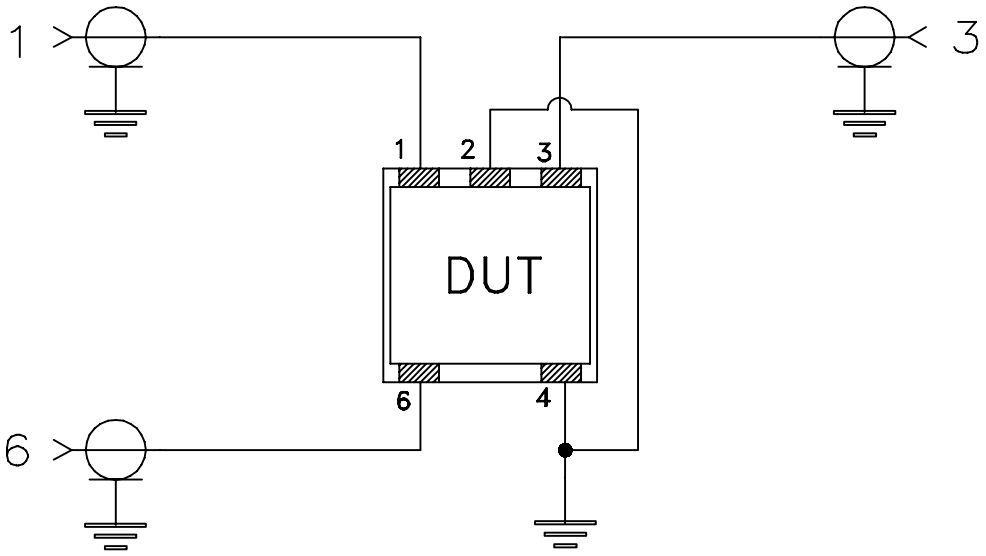
FILE:	SCALE:	SHEET:
98PL244	8:1	1 OF 1

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers RO4350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

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Environmental Specifications ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

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